TOSHIBA Transistor Silicon NPN Epitaxial Planar Type

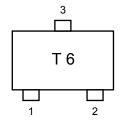
# **MT3S19R**

VHF-UHF Band Low-Noise, Low-Distortion Amplifier Applications

#### **FEATURES**

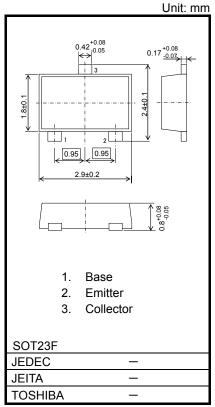
- Low Noise Figure:NF=1.5dB(Typ.) (@ f=1GHz)
- High Gain:|S21e|2=13dB(Typ.) (@ f=1GHz)

#### Marking



### **Absolute Maximum Ratings (Ta = 25°C)**

Characteristics	Symbol	Rating	Unit
Collector-base voltage	$V_{CBO}$	12	V
Collector-emitter voltage	V <sub>CEO</sub>	6	V
Emitter-base voltage	V <sub>EBO</sub>	2	V
Collector-current	IC	80	mA
Base-current	ΙΒ	10	mA
Collector power dissipation	P <sub>C</sub> (Note1)	320	mW
Junction temperature	Tj	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C



Weight: 11 mg (typ.)

Note 1: The device is mounted on a FR4 board (20 mm x 25 mm x 1.55 mm (t))

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## Microwave Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Transition frequency	f <sub>T</sub>	V <sub>CE</sub> =5V,I <sub>C</sub> =50mA	11.5	13.5	_	GHz
Insertion gain	S21e  <sup>2</sup> (1)	V <sub>CE</sub> =5V,I <sub>C</sub> =50mA,f=500MHz	_	18.5	_	- dB
	S21e  <sup>2</sup> (2)	V <sub>CE</sub> =5V,I <sub>C</sub> =50mA,f=1GHz	11	13	_	
Noise figure	NF	V <sub>CE</sub> =5V,I <sub>C</sub> =20mA,f=1GHz	_	1.5	1.9	dB
3 <sup>rd</sup> order intermodulation distortion output intercept point	OIP3	$V_{CE}$ =5 $V$ , $I_{C}$ =50 $m$ A, $f$ =500 $M$ Hz, $\Delta f$ =1 $M$ Hz	29.5	33.5	_	dBmW

## Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур	Max	Unit
Collector cut-off current	I <sub>CBO</sub>	V <sub>CB</sub> =6V,I <sub>E</sub> =0	_	_	100	nA
Emitter cut-off current	I <sub>EBO</sub>	V <sub>EB</sub> =1V,I <sub>C</sub> =0	_	_	100	nA
DC current gain	h <sub>FE</sub>	V <sub>CE</sub> =5V,I <sub>C</sub> =50mA	100	_	250	_
Reverse transfer capacitance	C <sub>re</sub>	V <sub>CB</sub> =5V,I <sub>E</sub> =0, f=1MHz (Note3)	_	0.75	1	pF

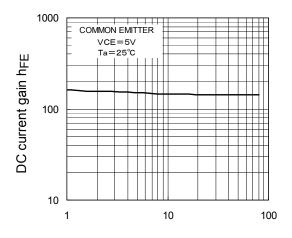
Note 3: C<sub>re</sub> is measured using a 3-terminal method with capacitance bridge

#### Caution:

This device is sensitive to electrostatic discharge.

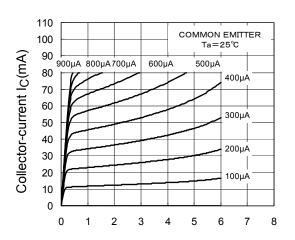
Please make enough tool and equipment earthed when you handle.

h<sub>FE</sub>-I<sub>C</sub>



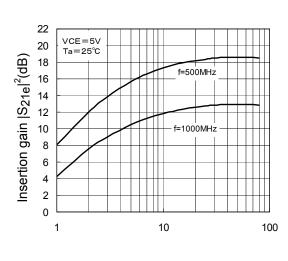
Collector-current I<sub>C</sub>(mA)





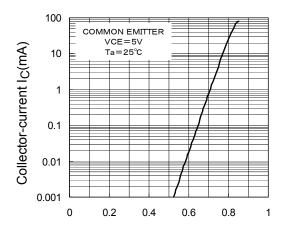
Collector-emitter voltage  $V_{CE}(V)$ 

## |S<sub>21e</sub>|<sup>2</sup>-I<sub>C</sub>



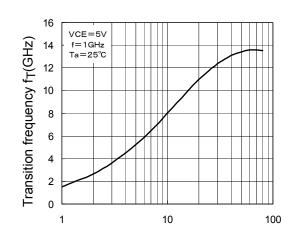
Collector-current I<sub>C</sub>(mA)

#### IC-VBE



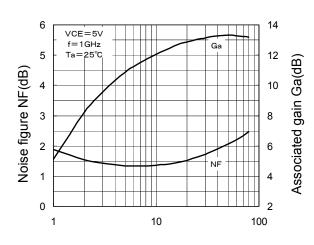
Base-emitter voltage V<sub>BE</sub>(V)

#### f<sub>T</sub>-I<sub>C</sub>



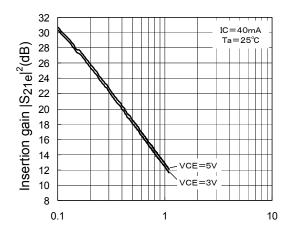
Collector-current I<sub>C</sub>(mA)

### NF, Ga -I<sub>C</sub>



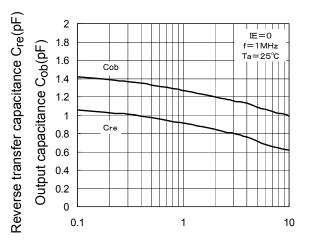
Collector-current I<sub>C</sub>(mA)

|S<sub>21e</sub>|<sup>2</sup>-Freq.



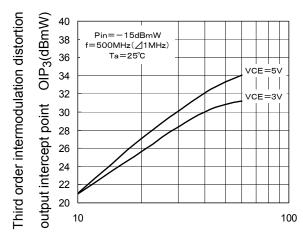
Frequency (GHz)





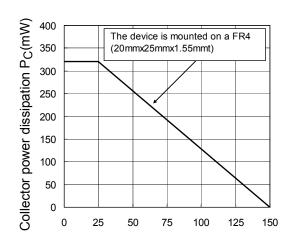
Collector-base voltage V<sub>CB</sub>(V)

OIP<sub>3</sub>-I<sub>C</sub>



Collector-current I<sub>C</sub>(mA)

P<sub>C</sub>-T<sub>a</sub>



Ambient temperature T<sub>a</sub>(°C)

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